GooLED

GooLED-LUME-4868 Pin Fin Heat Sink Φ48mm for Lumens

Features VS Benefits

* The GooLED-LUME-4868 Lumens Pin Fin LED Heat Sinks are specifically designed for
  luminaires using the Lumens LED engines.
* Mechanical compatibility with direct mounting of the LED engines to the LED cooler and
  thermal performance matching the lumen packages.
* For spotlight and downlight designs from 600 to 1,800 lumen.
* Thermal resistance range Rth 4.35°C/W.
* Modular design with mounting holes foreseen for direct mounting of Lumens Ergon COB series,
  and AC-ALL series LED engines.
* Diameter 48.0mm - standard height 68.0mm Other heights on request.
* Forged from highly conductive aluminum.

Zhaga LED engine and radiator assembly is a unified future international standardization

* Below you find an overview of Lumens COB's and LED modules which standard fit on the Pin Fin LED Heat Sinks.

* In this way mechanical after work and related costs can be avoided, and lighting designers
  can standardize their designs on a limited number of LED Pin Fin LED Heat Sink.
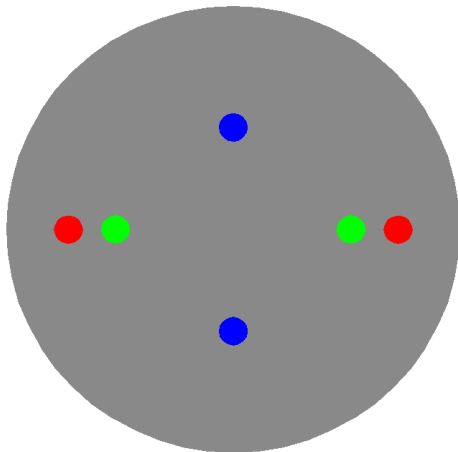
Lumens LED Modules directly Mounting Options

Lumens Ergon COB_HO, COB_HO+, COB_HE Series :

ERC1812xxxxHO;	ERC1812xxxxHE;
ERC1820xxxxHO;	ERC1820xxxxHE;

With the Zhaga Book 3 holders for the red indicator marks.
(Ideal Holder:50-2101CR);
(BJB holder:47.319.2131.50);
Without the holders for the green indicator marks.
Direct mounting with machine screws M3x6.5mm.

Lumens Ergon COB_HO, COB_HO+, COB_HE Series :

ERC1507xxxxHO;	ERC1507xxxxHO+;
ERC1512xxxxHO;	ERC1512xxxxHO+;
ERC1507xxxxHE;	

With the Zhaga Book 11 holders for the green indicator marks.
IDEAL Holder:50-2001CR;
BJB Holder:47.319.6104.50;
Without the holders for the blue indicator marks.
Direct mounting with machine screws M3x6.5mm.

Lumens AC-ALL Series :

EDC/38C/8W/xxx/120V/B	EDC/38C/8W/xxx/230V/A;
EDC/47C/10W/xxx/120V/B;	EDC/47C/10W/xxx/230V/A;
EDC/47C/12W/xxx/120V/B;	EDC/47C/12W/xxx/230V/A;
EDC/47C/15W/xxx/120V/B;	EDC/47C/15W/xxx/230V/A;

With the Zhaga Book 3 holders for the red indicator marks.
Direct mounting with machine screws M3x6.5mm.
Please refer to the www.lumensleds.com data provided on the manual.

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## Mounting Options and Drawings & Dimensions

Example:GooLED-LUME-4868-B-1,2

Example:GooLED-LUME-48 `1` - `2` - `3`

1 Height (mm)

2 Anodising Color

B-Black

C-Clear

Z-Custom

3 Mounting Options - see graphics for

details Combinations available

Ex.order code - 12

means option 1 and 2 combined

Notes:

- Mentioned models are an extraction of full product range.

- For specific mechanical adaptations please contact MingfaTech.

- MingfaTech reserves the right to change products or specifications without prior notice.

MOUNTING OPTION	Module type	Holder NO.	THREAD	THREAD DEPTH	THREAD HOLE DISTANCE
1	Ergon COB (15.85×15.85)	/	M3	6.5mm	22.0mm/ 2-@180°
2	Ergon COB (17.85×17.85)	/	M3	6.5mm	25.0mm/ 2-@180° (Zhaga book 11)
	Ergon COB (15.85×15.85)	BJB Holder 47.319.6104.50			
		Ideal Holder 50-2001CR			
3	AC-ALL Series	Lumens	M3	6.5mm	35.0mm/ 2-@180° (Zhaga book 3)
	Ergon COB (17.85×17.85)	BJB Holder 47.319.2131.50			
		Ideal Holder 50-2101CR			
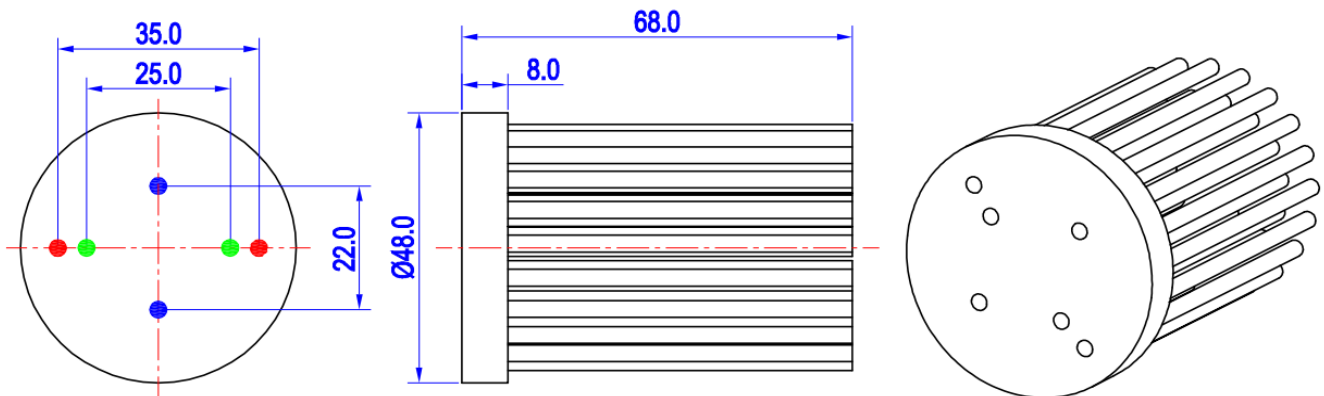
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The product deta table

Model No.	GooLED-LUME-4868
Heatsink Size	Φ48xH68mm
Heatsink Material	AL1070
Finish	Black Anodized
Weight (g)	93.0
Dissipated power (Ths-amb,50℃)	11.5 (W)
Cooling surface area (mm²)	31383
Thermal Resistance (Rhs-amb)	4.35 (°C/W)

### The thermal data table

* Please be aware the dissipated power Pd is not the same as the electrical power Pe of a LED module.

*To calculate the dissipated power please use the following formula: $Pd = Pe \times (1-\eta L)$.

Pd - Dissipated power ; Pe - Electrical power ; ηL = Light effciency of the LED module;

Pd = Pe x (1-ηL)		Heat sink to ambient thermal resistance Rhs-amb (°C/W)	Heat sink to ambient temperature rise Ths-amb (°C)
		GooLED-LUME-4868	
Dissipated Power Pd(W)	3.0	6.00	18.0
	6.0	4.83	29.0
	9.0	4.56	41.0
	12.0	4.33	52.0
	15.0	4.13	62.0

Heat sink to ambient temperature rise Ths-amb(°C)   **ta=25°C**
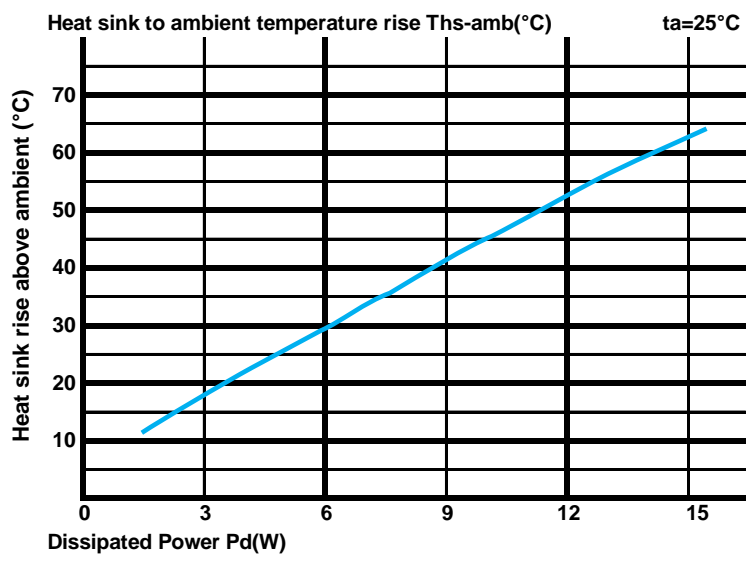
*The aluminum substrate side of the package outer shell is thermally connected to the heat sink via TIM (Thermal interface material).

MingFa recommends the use of a high thermal conductive interface between the LED module and the LED cooler.

Either thermal grease,A thermal pad or a phase change thermal pad thickness 0.1-0.15mm is recommended.
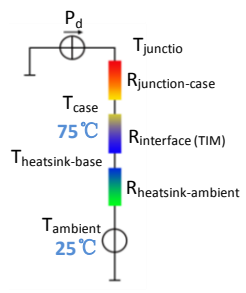
*Thermal resistance is a heat property and a measurement of a temperature difference by which an object or material resists a heat flow. Geometric shapes are different, the thermal resistance is different. Formula: $\theta = (Ths - Ta)/Pd$

θ - Thermal Resistance [°C/W] ; Ths - Heatsink temperature ; Ta - Ambient temperature ;

*The thermal resistance between the junction section of the light-emitting diode and the aluminum substrate side of the package outer shell is $R_{junction-case}$, the thermal resistance of the TIM outside the package is $R_{interface (TIM)}$ [°C/W], the thermal resistance with the heat sink is $R_{heatsink-ambient}$ [°C/W], and the ambient temperature is $T_{ambient}$ [°C].

*Thermal resistances outside the package $R_{interface (TIM)}$ and $R_{heatsink-ambient}$ can be integrated into the thermal resistance $R_{case-ambient}$ at this point.Thus, the following formula is also used:

$$T_{junction} = (R_{junction-case} + R_{case-ambient}) \cdot Pd + T_{ambient}$$